

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Toshiaki SUZUKI</td><td>06/30/2011</td></tr><tr><td>Zenta ANDOU</td><td>07/21/2011</td></tr><tr><td>Takashi NOZUE</td><td>07/21/2011</td></tr></tbody></table>		Name	Execution Date	Toshiaki SUZUKI	06/30/2011	Zenta ANDOU	07/21/2011	Takashi NOZUE	07/21/2011		
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<table border="1"><tr><td>Name:</td><td>NINTENDO CO., LTD.</td></tr><tr><td>Street Address:</td><td>11-1, Hokotate-cho, Kamitoba, Minami-ku, Kyoto-shi</td></tr><tr><td>City:</td><td>Kyoto</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>601-8501</td></tr></table>		Name:	NINTENDO CO., LTD.	Street Address:	11-1, Hokotate-cho, Kamitoba, Minami-ku, Kyoto-shi	City:	Kyoto	State/Country:	JAPAN	Postal Code:	601-8501
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<table border="1"><tr><td>Name:</td><td>HAL LABORATORY, INC.</td></tr><tr><td>Street Address:</td><td>1-22, Kandasuda-cho, Chiyoda-ku</td></tr><tr><td>City:</td><td>Tokyo</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>101-0041</td></tr></table>		Name:	HAL LABORATORY, INC.	Street Address:	1-22, Kandasuda-cho, Chiyoda-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	101-0041
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
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PATENT
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NAME OF SUBMITTER:	Mark E. Nusbaum
Total Attachments: 2 source=ASSIGNMENT#page1.tif source=ASSIGNMENT#page2.tif	

ASSIGNMENT OF PATENT APPLICATION

(Inventors) Toshiaki SUZUKI
Zenta ANDOU
Takashi NOZUE

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(Assignee) (1) NINTENDO CO., LTD.
(Address) of 11-1, Hokotate-cho, Kamitoba, Minami-ku, Kyoto-shi, Kyoto 601-8501 Japan
(Assignee) (2) HAL Laboratory, Inc.
(Address) of 1-22, Kandasuda-cho, Chiyoda-ku, Tokyo 101-0041 Japan

(Other Countries) (hereinafter designated as the Assignee) the undersigned's entire right, title and interest in the invention, and all application(s) for patent and any Letters Patent which may be granted therefor, known as
(Title) STORAGE MEDIUM RECORDING IMAGE PROCESSING PROGRAM, IMAGE PROCESSING DEVICE, IMAGE PROCESSING SYSTEM AND IMAGE PROCESSING METHOD

for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed on or has already filed in U.S. appln. Serial No. , filed on

The undersigned acknowledges an obligation of assignment of this invention to said assignee at the time the invention was made.

The undersigned agree(s) to execute all papers and documents necessary in connection with the application or any interference which may be declared and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient and further to perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of NIXON & VANDERHYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhye P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s).

Date June 30, 2011 Signature of inventor

Toshiaki Suzuki

Toshiaki SUZUKI

Date July 21, 2011 Signature of inventor

Zenta Andou

Zenta ANDOU

Date July 21, 2011 Signature of inventor

Takashi Nozue

Takashi NOZUE

Date _____ Signature of inventor

Date _____ Signature of inventor

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